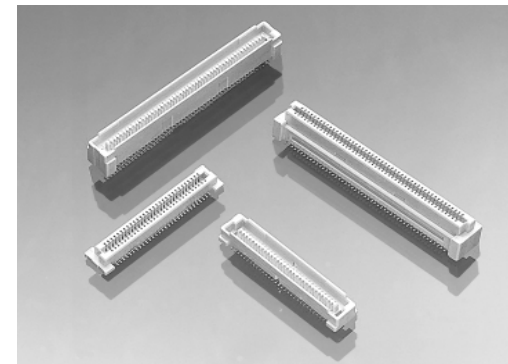


0.8mm Free Height (FH) Connector with a preface on general mezzanine connector applications



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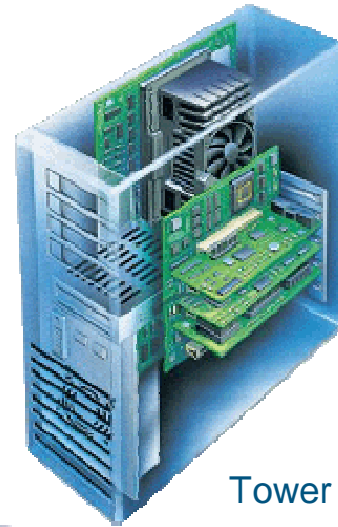
Mezzanine Connector Overview

- Broad product offering
 - Large range of stack heights
 - Large range of contact densities
 - Impedance controlled high speed products
- Products available to meet various application cost/performance needs
- Product Portfolio expanding
 - Lower cost impedance controlled connectors
 - BGA Array style connectors
- Certified Alternative Sources
 - Fully tested for intermateability/interchangeability

Mezzanine Connector Typical Applications

Interconnects for small function cards or personality modules which contain chip sets (ASIC's, CPUs, memory modules), function modules, or transceivers.

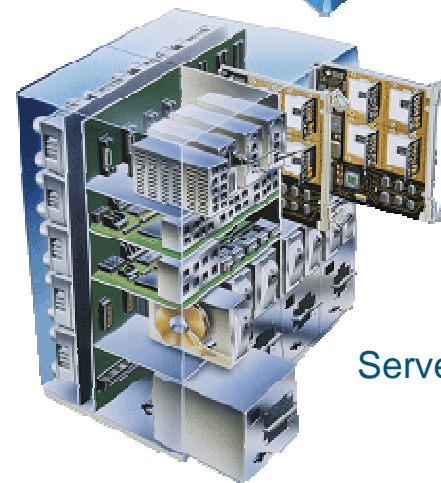
- Servers
 - Switches
 - Notebooks
 - Consumer Electronics
 - Base Stations
- Virtually every printed circuit board has a mezzanine connector



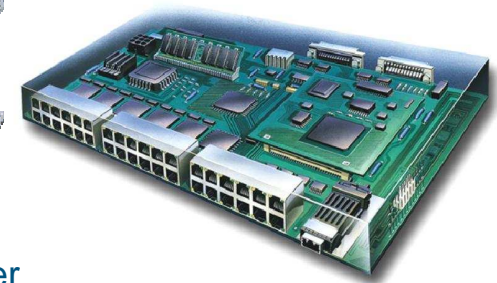
Tower Server



Notebook



Server



Stackable Switch

Mezzanine Connector Applications



Application

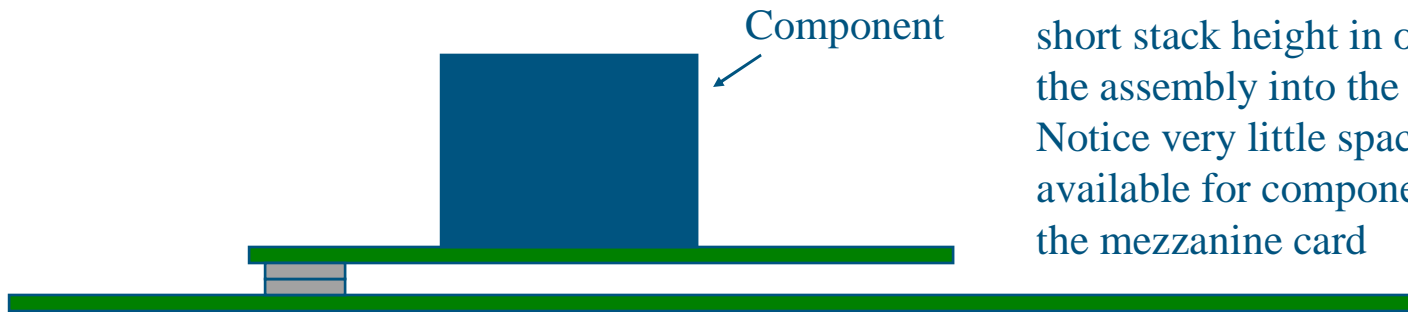
- To increase the functionality of a single card



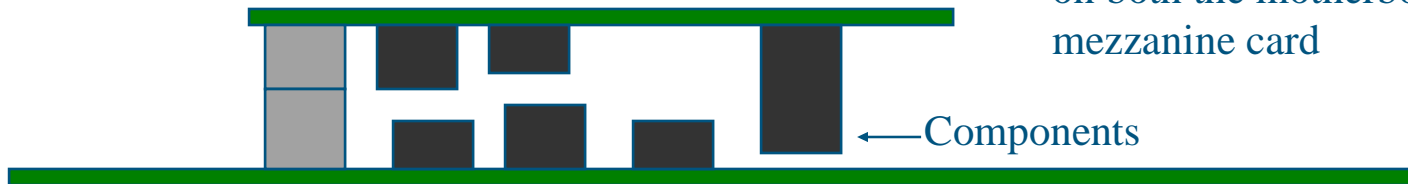
Application

- To reduce motherboard complexity and cost. Hard to route ASIC's would be separated from the more commercial motherboard.

Mezzanine Connector – Stack Height Considerations

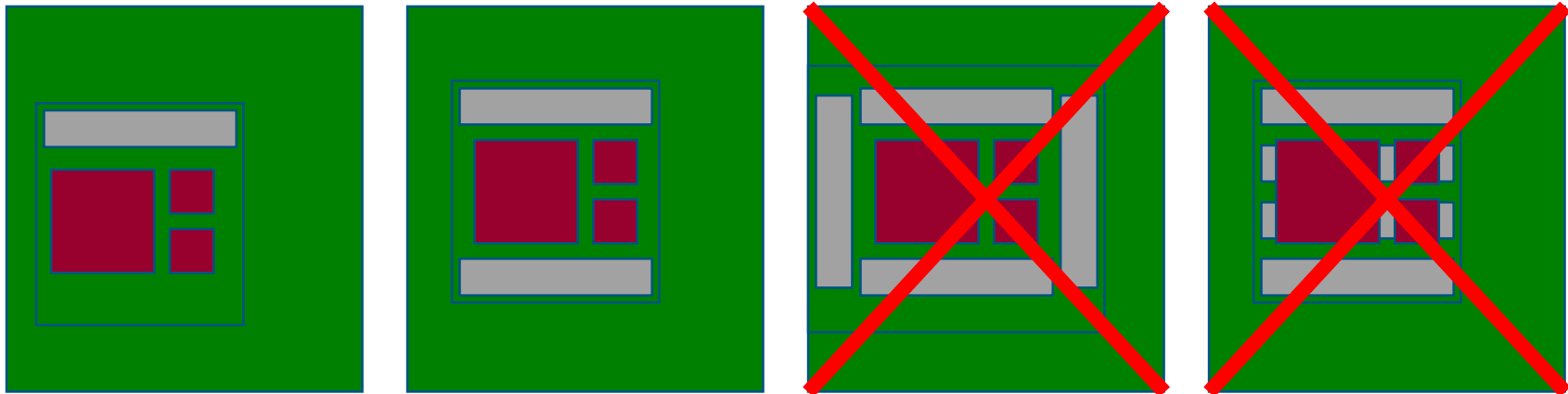


Tall components on the mezzanine card often require a short stack height in order to fit the assembly into the final box. Notice very little space is available for components under the mezzanine card



The mezzanine stack height must provide clearance for components on both the motherboard and the mezzanine card

Mezzanine Connector- Application



Tolerance considerations are critical to a successful application.

Note: Mating multiple surface mount mezzanine connectors simultaneously is very difficult due to necessarily small tolerances. Careful consideration needs to be given if more than one connector set is to be mated.

Mezzanine Connector-Application

- Physical space constraints
- Thermal requirements
- System customization such as I/O
- System upgrade capability
- Reduction in entry level system cost
- System test points by means of a cable

Mezzanine Connectors

Questions to consider before making a product selection

1. What range of stack heights will work in the application (min and max)?
2. How much space is available (length and width) for the connector?
3. How many differential pairs are required?
4. What is the minimum rise time of the differential pairs?
5. How many single-ended lines are required? Are any of them high-speed?

Mezzanine Connectors

Questions to consider before making a product selection-cont'd

6. How many of the single-ended lines are high-speed (<500ps risetime)?
7. Do you need to bring power onto the daughtercard?
 - How many voltages?
 - How many amps for each voltage?
8. What printed circuit board attachment do you prefer?
 - Surface mount, thru-hole solder, press-fit
9. Do you have a contact pitch that you prefer or will any that meet the above suffice?
10. When will product be required?

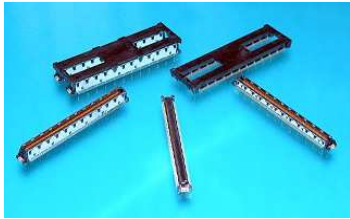
Mezzanine Connector- Market Observations

- Significant growth is expected in applications which require high density and high speed products
- SMT processing with pick & place components is increasingly a cost effective application approach
- The mezzanine market is
 - fragmented with limited standardization
 - limited footprint compatible/intermateable high speed product designs
- A large range of stack heights is required to meet customer needs
- Packaging options important

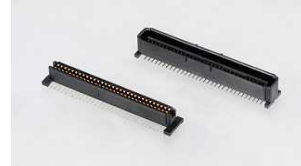
Mezzanine Connector- Tyco Electronics' Product Portfolio Offers:

- Flexibility
 - Broad offering for various application needs
 - Price/Performance options
 - Packaging options
 - Dual sources for intermateable/interchangeable products
- Performance
 - Offering covers data rates to 15 Gbps
- Experience
 - Providing high speed mezzanine connectors since the early 1990's

A Partial Selection of the Tyco Electronics Mezzanine Portfolio



.5mm FH Connector



1mm FH (IEEE1386) Connector



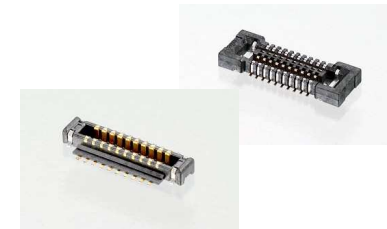
STRADA Mesa Connector



Fine Mate Connector



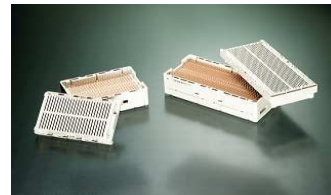
.8mm FH Connector



Fine Stack Connector



MICTOR Connector

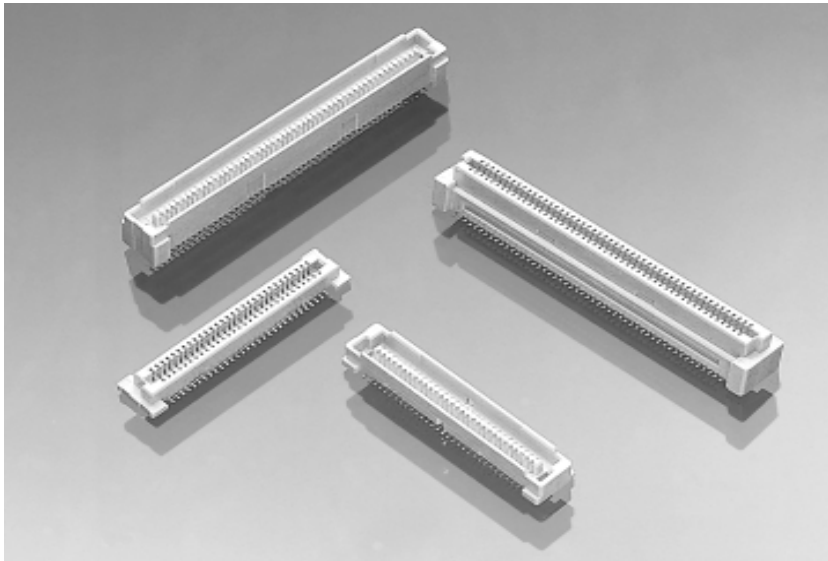


STEP-Z Connector



MICTOR SB Connector

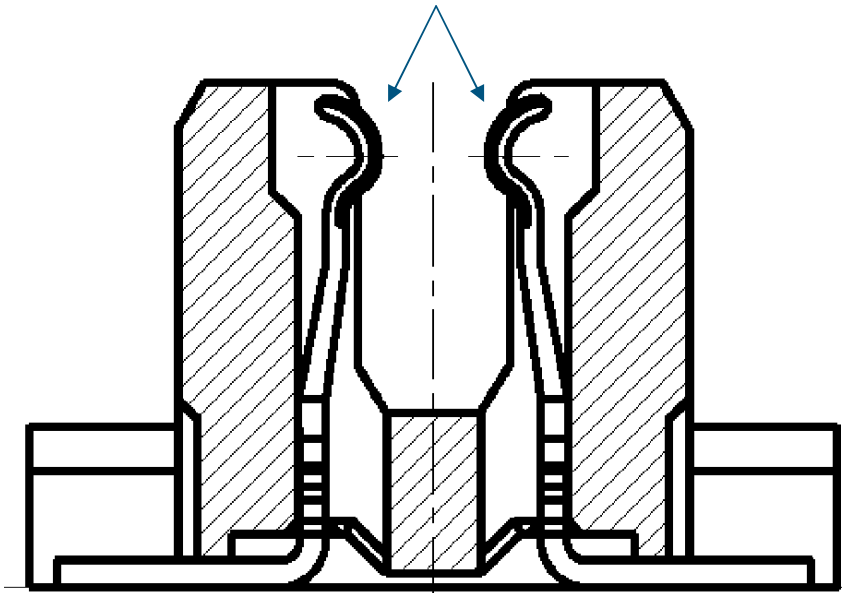
0.8mm Free Height (FH)



- Our highest volume stacking connector family, with over 5,000 customers.
- Availability
 - 5mm through 20mm stack height
 - 40 through 200 positions
 - 30 Au options have recently been released across the line
 - Packaging in tubes or tape and reel, with or without vacuum pickup caps

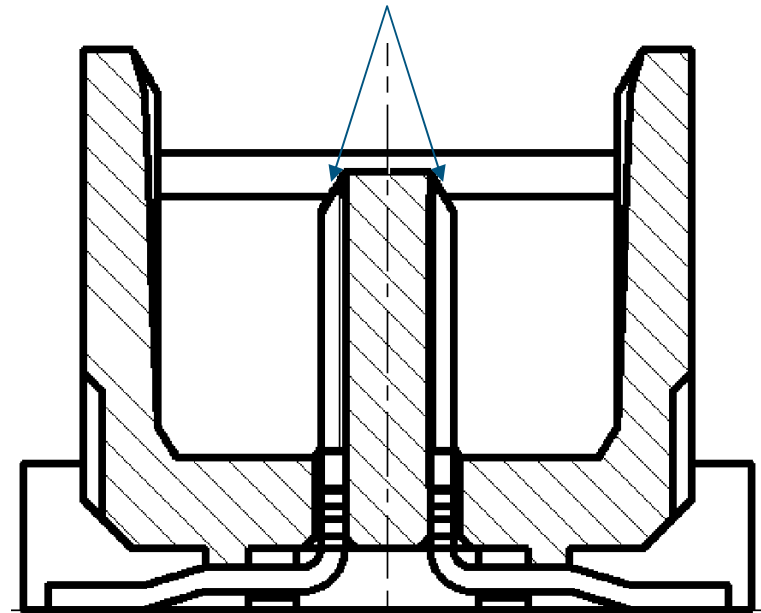
0.8mm Free Height Connector Cross-Section

Receptacle Contacts



Receptacle Cross-Section

Plug Contacts

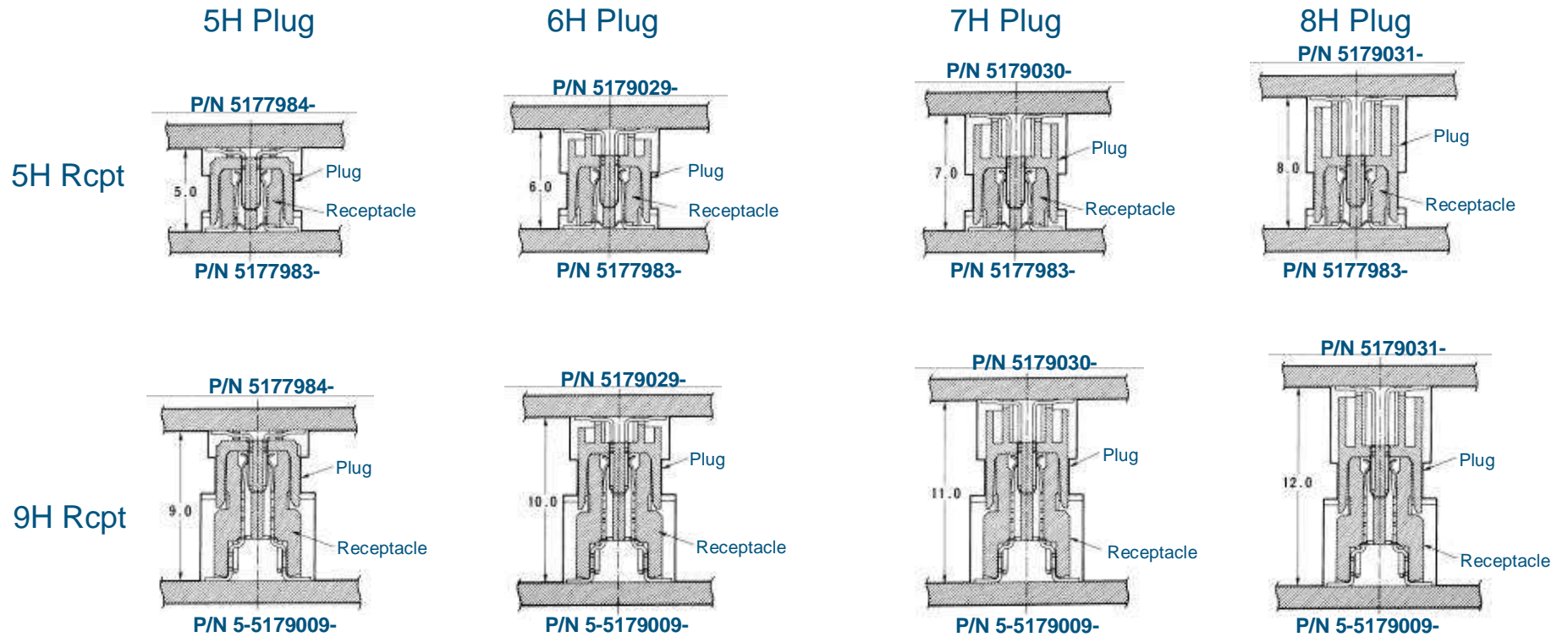


Plug Cross-Section

0.8mm FH Stack Heights

- How to achieve a final mated stack height using 0.8mm FH
 - Four heights are available for both the Plug and Receptacles, which when mated achieve 16 different stack heights. The term “Height” is a product attribute without a physical dimension, and is often referred to as simply “H”.
 - Use the formula below to calculate a mated stack height:
 - $[(\text{Rcpt H} + \text{Plug H}) - 5] = \text{Mated Stack Height in mm's}$
 - For example: $[(13\text{H Rcpt} + 6\text{H Plug}) - 5] =$
 $[(13 + 6) - 5] = 14\text{mm Mated Stack Height}$

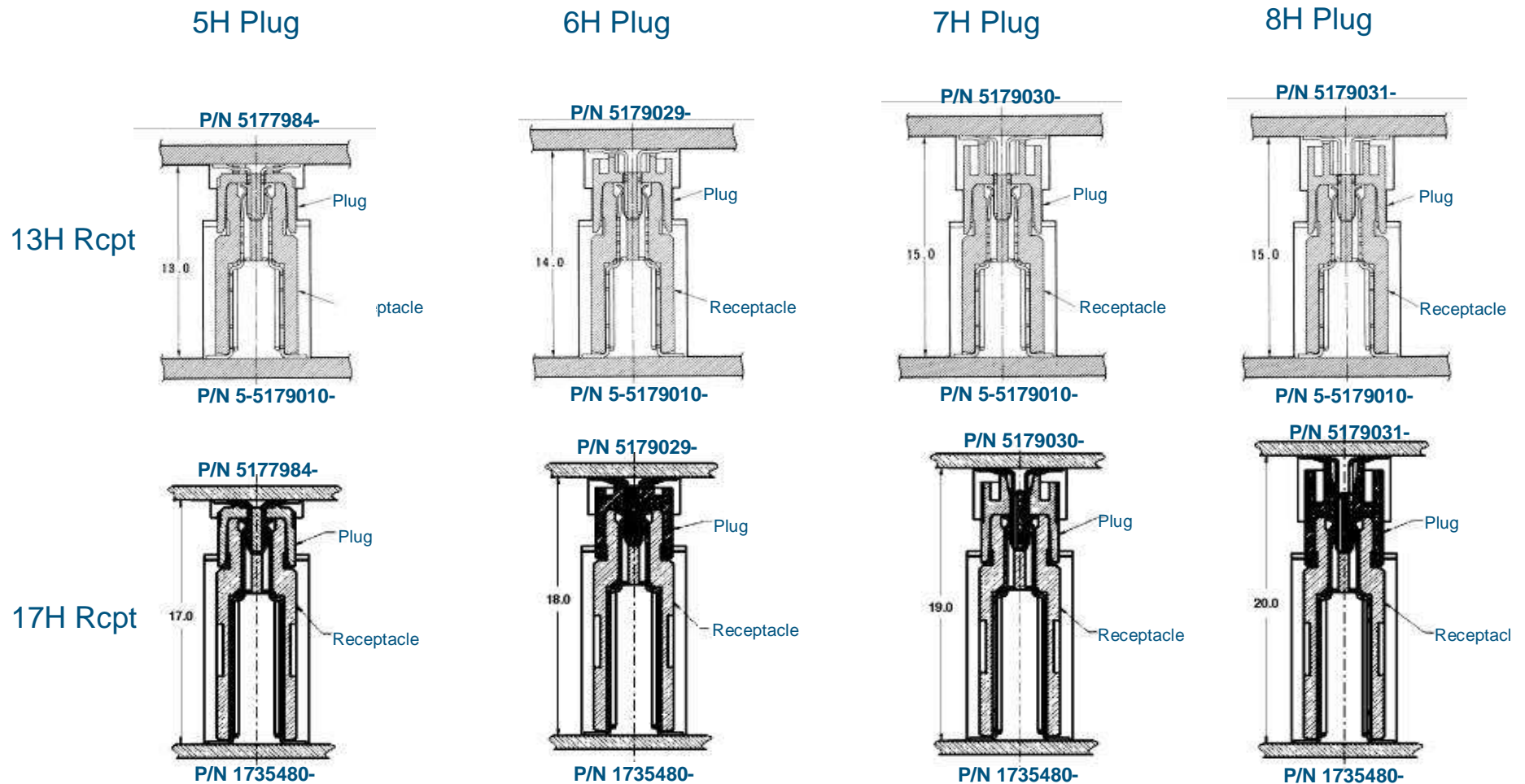
0.8mm FH Connector Stack Heights



Representative Drawing Numbers shown

$$[(\text{Rcpt H} + \text{Plug H}) - 5] = \text{Mated Stack Height in mm's}$$

0.8mm FH Connector Stack Heights cont'd



Representative Drawing Numbers shown

$$[(\text{Rcpt H} + \text{Plug H}) - 5] = \text{Mated Stack Height in mm's}$$

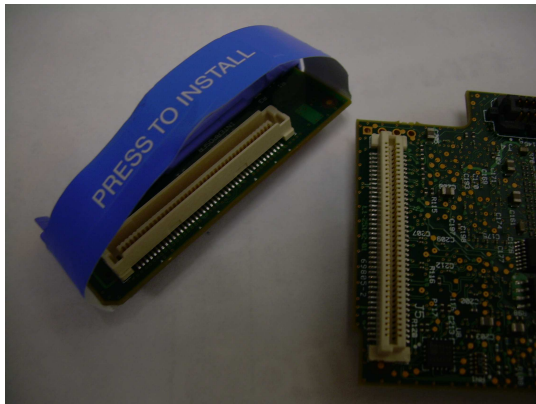
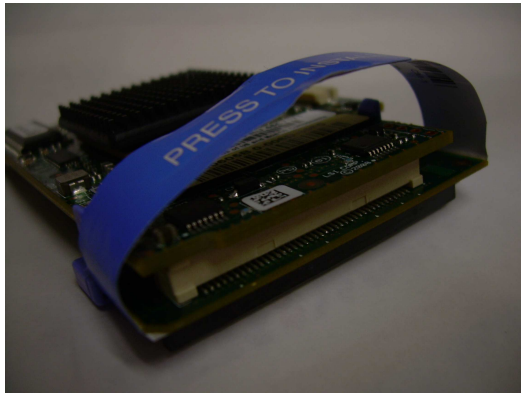
Photo of All Stack Heights Tooled for 0.8mm FH Connector



0.8mm Free Height Connector

Typical Application Photos

- Photos courtesy of TEC customers



Electrical Performance Goes Beyond the Connector

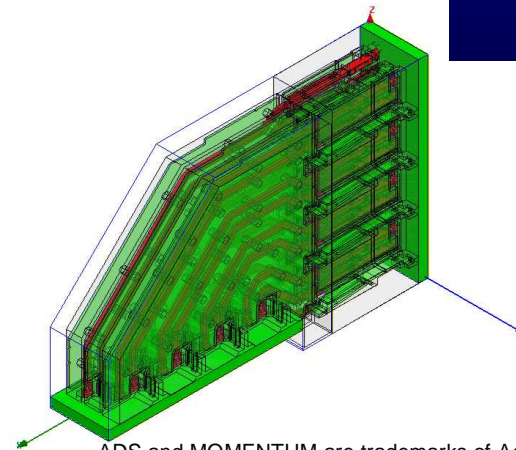
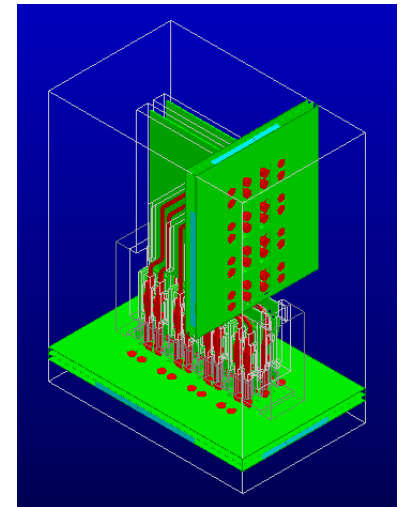
- Signal Integrity support
 - Knowledge and expertise at many levels
 - Connector, Footprint, System
 - Modeling
 - Simulation
 - Testing
- Working with silicon developers

Circuit and Design (SI) Overview

- Modeling
 - Connectors
 - Cables
 - Printed circuit boards
 - Systems
- Testing (2 labs)
 - Passive
 - Active
 - EMI
- Standards Support
- Models for customers
- Test boards for customers
- Customer design support

Modeling Tools

- Component Modeling
 - **ANSOFT 2D** Field solver – (time domain) modeling –
Connectors/Footprints
 - ANSOFT Q3D Field solver – (time domain) modeling –
Connectors/Footprints
 - ADS/MOMENTUM – (frequency domain) modeling –
 - **HFSS** – (frequency domain) modeling –
Connectors/Footprints
 - CST MICROWAVE STUDIO modeling –
Connectors/Footprints
 - **Transmission Lines**
- System Modeling
 - **ADS** – (frequency domain) modeling
 - MATLAB – (frequency domain) modeling
 - HSPICE – (time domain) modeling



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HSPICE is a trademark of Synopsis, Inc.
MATLAB is a trademark of Math Works, Inc.